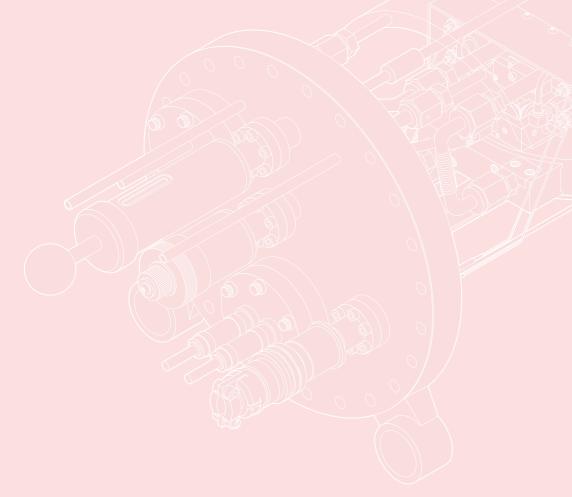
# Section 8



# e-Vap® thin film deposition

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# Thin film deposition technology

#### Introduction

#### Thin film deposition

Thin film deposition of metallic, insulating, conductive and dielectric materials plays an important role in a large number of manufacturing, production and research applications. Resistance heating, sputtering and electron beam are the processes most widely used for the deposition of thin film. Techniques employed to perform these processes differ in degree of sophistication and quality of film produced. A resistance-heated evaporation source is relatively simple and inexpensive, but the material capacity is very small. Sputter deposition can be used to coat large areas and complex surfaces in production coating environments utilising time and power for rate control.

Electron beam evaporation is the most versatile means of vacuum evaporation and deposition. This technique allows the production of thin film coatings from pure elements, including most metals, as well as numerous alloys and compounds. Electron beam evaporation offers several advantages over competing processes, including: precise control of low or high deposition rates; excellent material utilization; co-deposition and sequential deposition systems; and, a uniform low-temperature deposition.

Use of electron beam offers higher evaporation rates, freedom from contamination, precise rate control at very low deposition levels, precise film composition and cooler substrate temperatures.

The materials used for evaporation are available in near limitless shapes and forms, the most common being pellets, slugs and disks. Since the introduction of electron beam evaporation in the 1950s, the development of high-performance films and complex coating processes has been delayed by the lack of modern electron beam equipment and technology.

Caburn-MDC's e-Vap® product line has taken this challenge head-on and provides electron beam evaporation sources and control electronics that incorporate leading edge technologies unmatched in the industry.

#### Thin film applications

Thin film applications requiring electron beam evaporation are always increasing. Applications are found in the medical, metallurgical, telecommunication, microelectronic, optical coating and semiconductor industries. Electron beam evaporation sources are employed in the production of a multitude of low and hi-tech products including: sunglasses, camera lenses, optical filters, infrared detectors, superconductors, automotive decorative trim, costume jewellry, corrosion-resistant surfaces and many others.

Electron beam deposition is ideal for research and production applications due to its widespread material availability, efficient material utilisation and unmatched film purity and uniformity.

#### e-Vap® product line

The e-Vap® product line is as vast as the applications requiring electron beam evaporation. Each and every e-Vap® source is designed to meet or surpass the stringent requirements put forth by the vacuum coating industry. As a leader and innovator in this field, MDC holds various patents in electron-beam evaporation technology. Two notable U.S. patent numbers are 5,418,348 and 5,473,627.

The first is for Caburn-MDC's unique electron source design, which incorporates higher material capacity with a dramatically smaller source footprint. The second, for an ingenious coolant delivery system incorporated into Caburn-MDC's UHV multi-pocket rotary sources. e-Vap® electron beam sources are available in six basic sizes, called frames, which can accommodate small research as well as large production coating requirements with crucible capacities from 2cc to 400cc.

The sources are offered individually or as complete turn-key, flange-mounted systems with all necessary service connections, including fluid and electrical feedthroughs. These state-of-the-art evaporation sources are powered and controlled with equally advanced solid state switching power supplies, beam sweepers and control electronics. The highest rated power supply is capable of a 15,000W output at negative 10,000V, fits on a standard 483mm rack, is only 260mm tall and weighs 45.5kg. Flange-mounted units are factory assembled and tested including all feedthroughs. A range of standard options include a watercooled collimator roof, a stepper motor indexer and a programmable XY sweep controller.

#### Miniature evaporation systems

Miniature evaporation systems include the e-Vap® 100, a precision, wire-fed electron beam source designed specifically for depositing monolayer thin films in ultrahigh vacuum environments. It can deposit refractory metals at an atomic level.

e-Vap® 3000 is a 2cc capacity, miniature electron beam evaporation system with a 3kW power supply. This is a versatile deposition tool used for thin film coating processes in high and ultrahigh vacuum environments. The e-Vap® 3000 system evaporates virtually all rare earth refractory and dielectric materials. It provides researchers a simple, relatively low-cost means of depositing high-purity thin film coatings.

Re-Vap<sup>TM</sup> resistive heater sources are also part of the miniature product line. These sources are available with filament boats or coils and oxide crucibles. Re-Vap<sup>TM</sup> sources are by far the most economical method of depositing thin films.

CABURN MDC

# Thin film deposition technology

#### Introduction

**Section 8** 

#### **Evaporation materials**

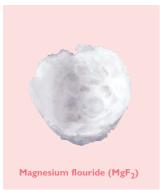
Caburn-MDC e-Vap® sources are rugged, reliable and easy to maintain. Electron beam evaporation is an extremely versatile means of depositing uniform high-purity thin films. Capable of reaching elevated temperatures in excess of 3500°C, evaporation of virtually any material can be accomplished.

The silica, hafnia and magnesium fluoride materials shown were produced using an e-Vap® power supply, e-Vap® source controller and e-Vap® programmable sweep controller with a standard figure-eight pattern at 200Hz sweep frequency. The continuous and superior performance of this arrangement permits the routine evaporation of these and other difficult materials.

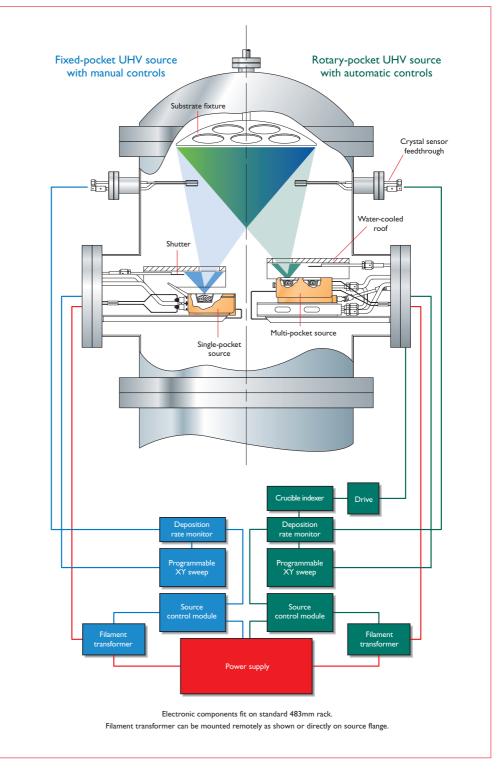








## Typical e-Vap® installation





#### Section 8.1

# Thermal evaporation systems

#### Resistive heater evaporation



#### **Features**

- 900W power supply
- 70mm Del-Seal™ CF flange mount
- Ideal for organic material evaporation
- CE Compliant
- Contact your local office for higher current models

#### **Specifications**

Cooling	Air cooled
Input power	208V±10%, single-phase, 50/60Hz, 7A
Voltage output	0 to 6V AC
Current output	0 to 150A
Weight	20.5kg
Dimensions Power supply Output cable	406w × 152h × 3051 2AWG × 3.05m

Caburn-MDC's Re-Vap™ resistive filament heater evaporation is an economical and reliable method of depositing thin film coatings in vacuum. Current passing through a resistive element generates sufficient heat to melt and evaporate various coating materials. Materials commonly evaporated using resistive heating include iron, nickel, aluminum, copper, tin, silver, gold and platinum. Re-Vap™ resistive evaporation can be used for decorative metallizing as well as demanding research applications.

Three basic resistive element designs are offered: filament coil, metal foil boat and oxide crucible types. Filament coil designs are by far the most popular. Re-Vap  $^{\text{TM}}$  heater elements are economical and disposable. They can be discarded after each use to prevent material contamination.

Re-Vap<sup>™</sup> coiled filaments are typically three stranded tungsten wires looped into coils. Multi-strand filaments are generally used because they offer a greater surface area than single wire filaments. Under these conditions, the evaporant charge should be small compared with the mass of the filament. The filament can hold up to Ig of evaporant material, formed into staple-like shapes and hung on the central helix of the tungsten filament. Upon melting, the evaporant wets to the filament and is held in place by surface tension. Spreading of the molten evaporant across the wire is desirable to increase evaporation surface area. This is accomplished by distributing the initial charge evenly over the entire length of the filament coil. To minimize dripping of the molten material, the filament coil temperature must be increased rapidly to between 1200°C and 1500°C. Using this technique, the molten material will climb or cling to the hot wire and vaporize efficiently.

Another type of element coil is the filament basket, used to evaporate pellets or chips of materials which either sublime or do not wet the filament wire upon melting. If wetting occurs, the coils of the basket are shorted and the temperature of the source drops.

Metal foil boat type resistive elements are yet another choice for small evaporation applications. Metal foil boats are made from thin refractory metal stampings, usually tungsten, molybdenum or tantalum. These boats have dimples which hold the evaporation material. Their miniature size and small capacity make them ideal for small evaporation jobs. Metal foil boats operate at very high temperatures and may cause alloying to occur with certain types of evaporation materials. Wetting of the metal surface by the molten evaporant is desirable in the interest of good thermal contact, however, the molten metal will lower the electrical resistance of the foil in the melt area, thereby causing a drop in temperature. This problem can be eliminated by using a boat which has been coated with a thin layer of aluminum oxide. The oxide coating will not allow wetting of the molten metal evaporant to the metal foil element.

Crucible heaters are an open, circular wound filament which allows crucibles to be inserted inside the windings. The crucibles are commonly manufactured from alumina, carbon, quartz and boron nitride. Crucibles have insulating properties which form a thermal barrier between the filament and melt, allowing a uniform melt temperature. Crucible evaporation is very stable because of its uniform heating. A wide range of low to moderate temperature metals like palladium, tin, selenium, arsenic, indium and organic materials evaporate well from crucibles. Crucibles are less prone to failure compared to metal foil boats because of the complete isolation between the evaporant and the heater element, thus eliminating shorting or alloying.







Description	Reference	Part number
Complete system <sup>1</sup>	RH-900	992626
900W power supply	RH-PS-900	991256
Resistive source assembly <sup>2</sup>	RH-F-900	992625
Conductor extension kit	RH-CEK-900	992619
Power supply spare parts kit	RH-PSPK-900	991257-08
Metal foil boat, tungsten	RH-MFB-900TU	992624-01
Metal foil boat, tantalum	RH-MFB-900TA	992624-02
Metal foil boat, molybdenum	RH-MFB-900M	992624-03
Coated foil boat, tungsten	RH-CFB-900TU	992623-01
Coated foil boat, molybdenum	RH-CFB-900M	992623-02
Filament coil	RH-FC-900	992622
Filament basket	RH-FB-900	992621
Oxide crucible, alumina	RH-OC-900A	992620-01
Oxide crucible, boron nitride	RH-OC-900BN	992620-02
Oxide crucible, quartz	RH-OC-900Q	992620-03

- <sup>1</sup> Includes power supply and resistive source assembly
- <sup>2</sup> Includes filament coil heater element

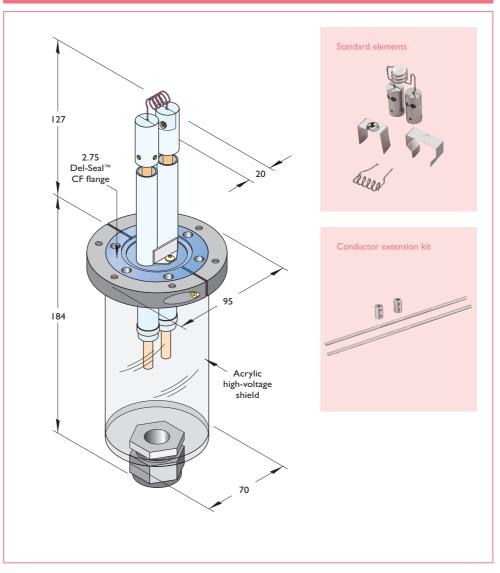
#### Heater elements

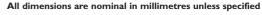
# Coated metal foil boat

# Filament coil



## Resistive heater source assembly









Power supply

Section 8.1



#### **Features**

- 3000 watt output
- Designed for industrial/production applications
- Compact size mounts underneath chamber
- High frequency switching power supply
- 5 or 10 volt tap option
- Connects to Sigma or Inficon rate controllers making it stand-alone capable
- CE Compliant
- 6000 watt stack option

#### **Specifications**

Cooling	Air cooled
Input power	208/220/240V AC, single-phase, 50/60Hz, 25A
Power output	0 to 5V DC @ 600A
Option	0 to 10V DC@300A
Cable	I.8m cable included
Weight	14kg shipping
Dimensions	127w × 203h × 330d

#### **Description**

Caburn-MDC's high-powered Re-Vap<sup>™</sup> resistive evaporation system is a highly industrial, robustly designed, economical method of depositing thin film coatings. The current passing through a resistive element (filament, boat, etc.) is produced by a unique high-current, lowvoltage switch mode high-



frequency power supply that produces ample amounts of current needed to evaporate materials such as iron, nickel, aluminum, copper, silver, gold and platinum. Silicon-monoxide, magnesium fluoride, as well as zinc selenide are readily evaporated.

#### **Re-Vap**<sup>™</sup> **Power supply and controller**

Caburn-MDC has taken advantage of MDC's extensive knowledge of high frequency solid-state switching power supplies by incorporating that technology into a patent applied high-powered 3000W Re-Vap<sup>™</sup> power supply. Tremendous size and weight reductions are the result. With overall dimensions of  $127w \times 203h \times 330l$  and a total weight of just 9kg, the power supply can be mounted underneath the vacuum coating system just centimetres away from the highcurrent feedthroughs.

The power supply is only one-eighth the size and one-tenth the weight of a typical 3000 watt resistive power supply. Two unique advantages include higher power efficiency and floor space savings. Power efficiency is greater because the output cable length is reduced with a resulting reduction in power loss.

The Re-Vap<sup>™</sup> controller is a half-rack width display module displaying the current, voltage, safety interlock and status/operation indicators.

For automated coating processes, it may be connected to a rate/thickness controller for precise control. Power can also be controlled through the front panel or with the hand-held remote control.

#### Re-Vap™ clamp, high current feedthrough and **Z**-bar<sup>™</sup> extensions

The Re-Vap<sup>™</sup> positive clamping method is universally designed for heavy use and quick-change capability. Thumbscrews are provided for fast installation of boats or filaments. Air-side clamping uses silver-plated battery clampstyle hard copper connections designed for maximum surface contact and high current carrying capacity.

The Re-Vap<sup>™</sup> high current 19mm feedthroughs are rated at 600A. It uses high purity alumina ceramic as the dielectric material, which is hermetically sealed to a flexible metal transition using vacuum grade braze alloys in a vacuum brazing furnace. Additionally, a removable snap-on ground shield provides protection from line-of-sight coating on exposed ceramic surfaces. Re-Vap™ feedthroughs are fitted with Del-Base™ baseplate mounts in standard one-inch, 32mm or 34mm sizes for use in most vacuum coating systems, including Balzers and Leybold systems.

Z-bar™ extensions are used in cases where normally an evaporation source cannot be positioned because of spacing limitations. The modular Z-bar™ extensions allow you to manoeuvre your evaporation sources around fixed equipment inside your vacuum coating system. Its versatility allows you to use them singularly or in multiples for those hard to reach locations.

All dimensions are nominal in millimetres unless specified Weights given are approximate



#### Resistive heater evaporation



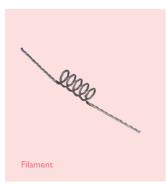


#### **Features**

- Industrial design
- Feedthroughs rated at 600A
- Removable, snap-on ground shield protects against coating build up
- Z-bars allow installation of sources in difficult or hard-to-reach locations
- Z-bars may be used singularly or in multiples
- Clamp designed for virtually any type of commercial heater element, up to 32mm wide
- Ultra positive clamping method

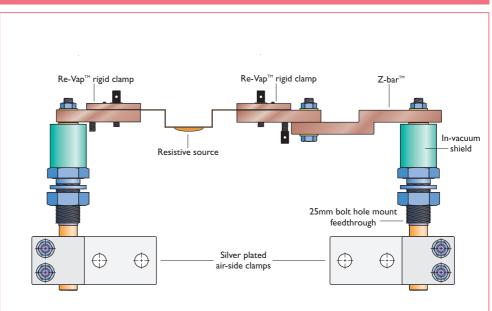
# Typical heater elements







#### Typical installation schematic



 Only one Z-bar shown – may be used in multiples





All dimensions are nominal in millimetres unless specified





#### Resistive controller

Section 8.1



#### **Features**

- Front panel LED displays current and voltage
- On/off switch
- Safety interlock
- Hand-held remote control
- CE compliant

#### **Description**

The Re-vap<sup>™</sup> resistive controller is designed for use with the Re-vap<sup>™</sup> 3000 power supply. The controller is a half-rack width display module, displaying the current, voltage, safety interlock and status/operation indicators. For automated coating processes, it may be connected to a rate/thickness controller for precise control. Power can also be controlled through the front panel or with the hand-held remote control. Cabling and connectors are

#### **Specifications**

			-4	
_0	nsi	tru	CL	IOI

Case	Aluminium sheet
Readout	LED display
Mount	Half-rack standard electronics cabinet
Input power	110V, 50/60Hz
Weight	
Dimensions	216w x 133h x 356d

#### **Ordering information**

#### **Complete system**

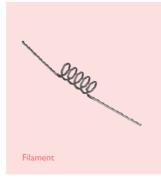
# A complete Re-Vap<sup>™</sup> 3000 system includes:

- One 3000 watt power supply
- One resistive controller
- Two high-current electrical feedthroughs, 25mm bolt style
- Two electrical airside clamps
- Two z-bars with bolts
- Two rigid boat clamp assemblies
- One metal foil boat heater element

# Components may be purchased as a complete system or individually.

Description	Wt kg	Reference	Part number
Complete system	23	RV-3000-SYS	992970
power supply	14	RV-3000-PS	991301
resistive controller	4.5	RV-3000-RC	991303







Resistive heater elements are sold individually.		
Reference	Part number	
Metal foil	993037	
Filament	993038	
Baffled	993039	

All dimensions are nominal in millimetres unless specified Weights given are approximate



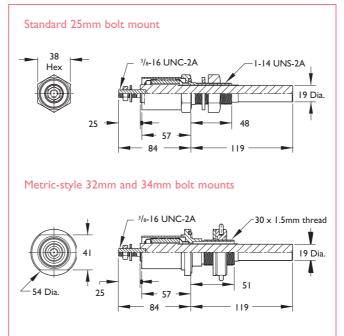


#### Accessories



High-current feedthroughs are available for mounting to baseplates in three standard sizes.

A removable shield protects ceramic insulator from contamination during deposition.



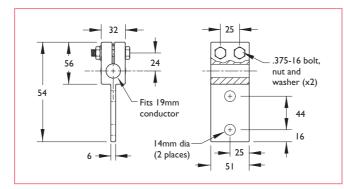
Reference	Part number
25mm bolt	992966
32mm bolt	993040
34mm bolt	993041
32mm – 25mm	991813

An adaptor is available to mount a 25mm bolt feedthrough to a 32mm bolt hole.

Adaptor not shown.

Two feedthroughs required, sold individually.

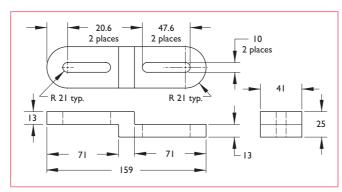




Reference	Part number
HCC-750	640070

Made of OFE copper with silver plate to minimise oxidation and contact resistance. Two 14mm holes are provided for fastening eyelet-fitted power cables. Sold

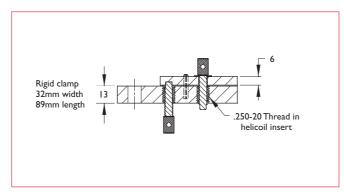




Reference	Part number
Z-Bar	992969

Caburn-MDC Z-bar<sup>™</sup> extensions are used where an evaporation source can't be positioned normally due to limited space. May be used singularly or in multiples. Sold individually.

Boat clamps



Reference	Part number
Rigid	992968-02

Boat clamps use thumbscrews for fast installation of boats of filaments. Two boat clamps are required. Sold individually.



# Miniature evaporation systems

eVap® 100

#### e-Vap® 100 System

#### **Specifications**

Digital emission current
Air cooled
220V ±10%, single-phase, 50/60Hz, 3A
2kV, DC negative polarity
Less than 2% RMS
1%
0 to 0.05A
ation 1%
85%
9kg
483w × 84h × 457l

#### **Features**

- 100W power supply
- Monolayer e-beam deposition
- Precision control deposition rates
- Imm wire feed mechanism, 2mm optional
- Refractory materials evaporation
- UHV compatible to 10<sup>-11</sup> Torr
- Bakeable to 250°C
- No water cooling required
- Mounted on 70mm Del-Seal™ CF flange

e-Vap® 100 is a precision monolayer deposition source employed for evaporative coatings in UHV applications. Its unique design uses an electron beam power source for thermionic emission and pinpoint electrostatic focussing of an electron beam onto a Imm diameter wire. The wire being evaporated is at ground potential and serves as the source anode, thus attracting electron bombardment. The constant stream of electrons heats the wire tip to its melting point forming a very small liquid ball, which is subsequently vaporized. The wire is manually fed by a precision linear drive feedthrough, and must be fed periodically as determined by source evaporation rates. The e-Vap® 100 source evaporates high-temperature refractory metals including tantalum, molybdenum and

#### Monolayer deposition rates

Li 0.4 Lithium	Be 1.3 Beryllium	Depositi substrat	Numbers indicate the time in minutes required to deposit one monolayer of the specified element. Deposition rates are calculated at element melting point, using a substrate area of 1cm², a source to substrate distance of 10cm and a vapour pressure of 10³ Torr.  These values are intended as reference only, actual rates may vary from those listed.						B 2.2 Boron	C 2.8 Carbon	Nitrogen	Oxygen			
Na 0.4 Sodium	Mg 0.6 Magnesium											AI 1.2 Aluminum	Si 1.5 Silicon	Phosphorus	<b>S</b> Sulphur
O.3 Potassium	Ca 0.6 Calcium	Sc 1.2 Scandium	Ti 1.6 Titanium	2.0 Vanadium	Cr 2.0 Chromium	Mn 1.7 Manganese	Fe 2.1 Iron	Co 2.2 Cobalt	Ni 2.2 Nickel	Cu 2. I Copper	<b>Zn</b> 0.9	Ga 1.8 Gallium	Ge 2.1 Germanium	As Arsenic	<b>Se</b>
Rb 0.4 Rubidium	Sr 0.7 Strontium	Y 1.4 Yttrium	Zr 2.1 Zirconium	Nb 2.7 Niobium	Mo 2.8 Molybdenum	Tc 3.0 Technetium	Ru 3.1 Ruthenium	Rh 2.8 Rhodium	Pd 2.4 Palladium	Ag 1.9 Silver	Cd 1.1 Cadmium	In 1.9 Indium	Sn Tin	Sb 1.4 Antimony	Te 1.4 Tellurium
<b>Cs</b> Caesium	Ba 0.8 Barium	La 1.7 Lanthanum	Hf 3.0 Hafnium	Ta. 4.0 Tantalum	4.3 Tungsten	Re 4.4 Rhenium	Os 4.5 Osmium	4.2 Iridium	Pt 3.7 Platinum	Au 2.9 Gold	Hg Mercury	<b>TI</b> Thallium	Pb 1.7 Lead	Bi 1.7 Bismuth	Po 1.5 Polonium
Fr	Ra	Ac													

0.4 Francium	Radium	2.0 Actinium		
	La	Ce	Pr	Nd

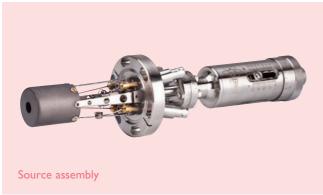
La 1.7 Lanthanum	Ce 2.6 Cerium	Pr 1.7 Praseodymium	Nd 1.7 Neodymium	Pm Promethium	Sm 1.4 Samarium	Eu 1.0 Europium	Gd 1.8 Gadolinium	Tb 1.9 Terbium	Dy 1.7 Dysprosium	Ho 1.8 Holmium	Er 1.8 Erbium	Tm 1.6 Thulium	Yb I.4 Ytterbium	Lu 2.1 Lutetium
Ac 2.0 Actinium	<b>Th</b> Thorium	Pa Protactinium	3.3 Uranium	Np Neptunium	<b>Pu</b> Plutonium	Am 2. I Americium	<b>Cm</b> Curium	<b>Bk</b> Berkelium	<b>Cf</b> Californium	<b>Es</b> Einsteinium	<b>Fm</b> Fermium	Md Mendelevium	No Nobelium	Lr

All dimensions are nominal in millimetres unless specified Weights given are approximate



eVap® 100

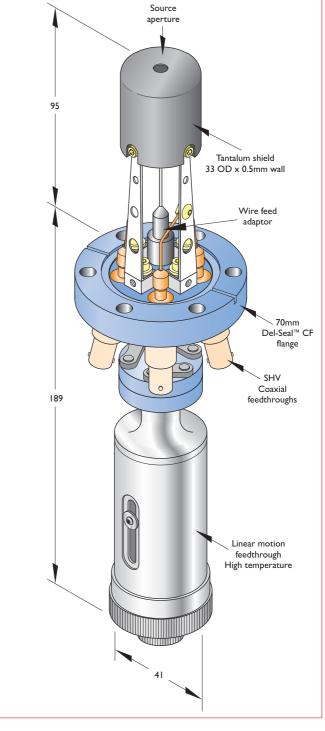




tungsten and most other materials manufactured in a wire form. High-temperature materials are not readily evaporated using Knudsen or Effusion cells, making the e-Vap® 100, because of its miniature size, an excellent physical vapour deposition evaporation source.

The elements table adjacent depicts calculated deposition rates for various pure materials. The e-Vap® 100 source is constructed with refractory metals for rapid equilibrium with minimal outgassing, to withstand elevated temperatures without the need for water cooling and to reduce the possibility of contamination in sensitive UHV applications. The source has an outgas mode to allow vacuum conditioning of the evaporation head. The degas feature allows heating of the e-Vap® 100 head to drive off any adsorbed contaminant. The source is mounted on a 70mm Del-Seal™ CF flange. Power connections are made via four, SHV-coaxial connectors clearly labelled for filament positive, filament negative, anode and screen inputs. Maintenance on the evaporation head is made simple with easy replacement of all key components.

The e-Vap® 100 power supply incorporates all switching technology for the high-voltage and filament sections. This translates to a smaller, lighter package, greatly improved arc suppression and better emission current control. Arcs are suppressed in the order of microseconds rather than millisecond response in other 50/60Hz systems. This, combined with lower levels of stored energy, prevents the molten tip of the evaporant rod from being 'blown away' during an arc, a common occurrence with older systems.



Description	Reference	Part number
Complete system <sup>1</sup>	EV-100	991029
Source assembly	EV-SA-100	992458
100w power supply	EV-PS-100	991192
Power supply spare parts kit	EV-PS-SPK-100	991257-07
2mm wire-feed adaptor	EV-2MM-100	992589
Filament set, 5 each	EV-FIL-100	992596

Includes source and power supply



All dimensions are nominal in millimetres unless specified



eVap® 3000

#### e-Vap® 300 System

#### **Features**

- 3kW switching technology power supply
- UHV compatible
- 70mm Del-Seal™ CF flange mount
- Includes water and electrical connections
- Evaporates refractory and dielectric materials
- CE compliant

#### **Specifications**

Metering	Digital emission current
Cooling	Power supply: air cooled Source: water cooled
Input power	220V ± 25V, single-phase, 50/60Hz, 18A
Voltage output	5kV, DC negative polarity
Output ripple	Less than 1% RMS
Voltage regulation	.025%
Current output	0 to 0.6A
<b>Emission current regul</b>	<b>ation</b> 0.25%
Efficiency	85%
Weight	29kg
Dimensions	483w × 267h × 483I

Caburn-MDC's 3kW electron beam source is a versatile and economical deposition tool used for thin film coating processes in high and ultra-high vacuum environments. The e-Vap® 3000 system evaporates virtually all rare earth refractory and dielectric materials. It provides researchers a simple, relatively low-cost means of depositing high-purity, thin-film coatings.

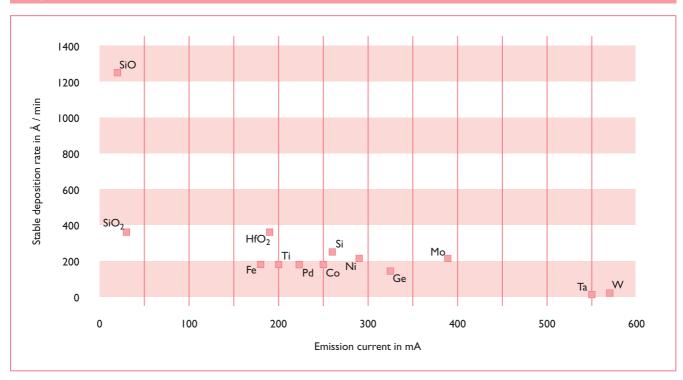
The source is manufactured using all metal sealed gaskets, is extremely compact and has a high level of ruggedness, reliability and efficiency. The compact source design allows the entire source assembly to fit through a 70mm Del-Seal™ CF port opening and eliminates internal water and electrical connections. This 3kW source is available free standing or as a complete turn-key system.

The filament/emitter assembly has a heat sink and features a unique single piece, high-voltage insulator design. The entire emitter assembly slides out for easy maintenance.

A new 3kW switching power supply is available to drive these miniature sources. State-of-the-art switching technology renders a compact, rack-mountable power supply. The built-in source controller also employs switching technology and provides extremely accurate e-Vap® evaporation sources.

These liners offer improved thermal stability while reducing the transfer of heat to the crucible. Liners provide the ability to easily and quickly switch evaporant materials without removing the crucible for cleaning. They also reduce power requirements to achieve specific evaporation rates. See page 594 for a detailed list of crucible liner materials.

#### Deposition rate V emission current



All dimensions are nominal in millimetres unless specified Weights given are approximate

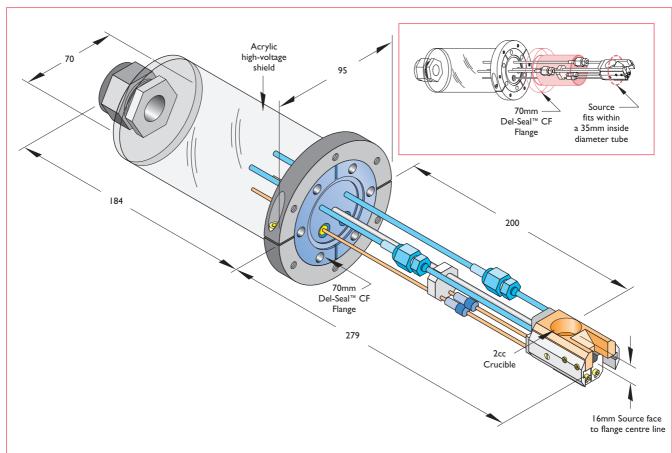


# Section 8.2 Miniature evaporation systems

eVap® 3000











Description	Reference	Part number
Complete system <sup>1</sup>	EV-CE-3000	992600
Source assembly	EV-SA-3000	992601
3000w power supply	EV-PS-CE-3000	991221
Filament set, 5 each	EV-FIL-3000	992610
Anode	EV-A-3000	991929
Beam former	EV-BF-3000	991922
Beam former insulator	EV-IBF-3000	990529
High voltage insulator	EV-IVH-3000	991921
Power supply spare parts kit	EV-PS-SPK-3000	991257-03

<sup>&</sup>lt;sup>1</sup> Includes source and power supply.





Mighty Source™



#### **Description**

Practical, low-cost and highly-reliable electron beam deposition sources are the future as we know it today. Caburn-MDC introduces the e-Vap® Mighty Source $^{TM}$  – a four-pocket by 2cc rotary electron beam source. Affordable and extremely compact, it stands just 61mm tall by 104mm long by 71mm wide. Is there anything smaller out there?

The Mighty Source™ is rated for 3kW of power which makes it an ideal deposition tool for evaporating metals, oxides, metal oxides and magnetic materials. Designed into the source body are two hermetically sealed XY axis sweep coils that allow you to sweep the electronbeam across the crucible pocket, resulting in the maximization of your coating process in terms of material stability and consistency.

The Mighty Source™ design is specifically tailored for the following uses: pilot production, lab, R&D applications and the university market place. Its compact design allows it to be mounted onto a 70, 150 or 254mm Del-Seal™ CF flange in either horizontal or vertical configurations. To complete this product system, MDC also offers a 3kW

#### **Specifications**

Maximum power	3000W
Operating voltage	5000V
Beam current	600mA
Compatible vacuum	2 × 10E-8 torr
Water flow	65psi or .62gpm
XY Sweep frequency	0 – 50Hz, 1.0A
Beam spot size	3 - 4m
Crucible material	OFE copper
<b>Bakeout temperature</b>	150°C
Crucible geometry	2.0cc volume crucibles × 4
Weight	2.7kg
Dimensions	61mm × 104mm × 71mm

#### **Modular source series**

#### **Features**

- Ideal for evaporating metals, oxides, magnetic materials and dielectrics
- Ideal for universities, lab/R&D, pilot production users
- Applications include metallization, MBE, nanotechnology, optics, microscopy and thin film heads
- Rated for 3000W of deposition power
- Four-pocket x 2cc rotating crucible
- Ultra-small footprint total size is 61h x 104l x 71w
- A contained permanent magnet design produces a very small, highly dense beam spot
- XY sweep coils are included
- Crucible drive can be driven from any position left, right, down and even angled
- Stand-alone, flange-mounted or turn-key assemblies are standard offerings
- Flange-mounts are installed on a 70mm Del-Seal™ CF flange
- Turn-key assemblies are installed onto a 150 or 254mm Del-Seal™ CF flange and include shutter and all electrical, water and mechanical feedthroughs – ready to operate.



 $e\text{-Vap}^{\otimes}$  Mighty Source<sup>TM</sup> horizontal source assembly I50mm CF flange



Special Control of the second control of the

Mighty Source™

#### Modular source series



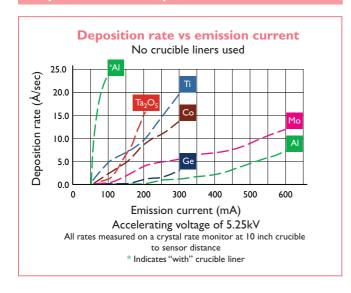


#### Flange-mounted assemblies

#### **Features**

- Complete turn-key assemblies plug 'n' play
- Horizontal assembly is supplied on a 150mm flange
- Vertical assembly is supplied on a 254mm flange
- Water-cooled roofs are available as an option
- Different flange sizes are available upon request

#### Deposition rate V power



#### **Deposition rate table**

Material	Sweep used Yes or No	Emission Current (MA)	Deposition rate (A/SEC)
Al	No	500	4.5
Al*	No	100	28.0
Al203	Yes	100	8.0
Ag	No	150	13.0
Со	No	200	9.0
Cr	Yes	50	13.0
Cu	No	500	2.2
Ge	No	300	3.0
Hf	Yes	250	7.0
HfO2	Yes	150	9.0
In	No	200	18.0
ITO	Yes	20	10.0
Мо	No	500	8.5
MgF2	Yes	10	7.0
Nb	No	500	1.0
Ni	No	300	3.0
Pd	No	100	50.0
Si	Yes	300	1.0
SiO2	Yes	40	25.0
Та	No	500	8.0
Ta205	Yes	150	7.0
Ti	No	300	20.0
TiO2	Yes	150	7.5
W	No	500	8.0
Υ	No	150	40.0
ZnS	Yes	30	10.0
ZnSe	Yes	10	40.0
ZrO2	Yes	200	10.0

<sup>\*</sup> With crucible liner





Accessories and consumables

#### **Modular source series**



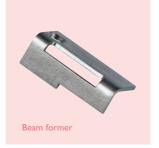


Description	Reference	Part number
Stand-alone source	*EV-	993400
70mm Del Seal™ flange horizontal mount	MS Mighty Source™	993450
254mm Del Seal™ flange vertical mount	EV-MS-F275-H	99343 I
150mm Del seal™ flange horizontal mount	EV-MS-F1000	993430
3kW mini sweep controller	EV-MS-F600H	991374
Power supply	SWEEP-MS	991221
Power supply spares kit	EV-PS-CE-3000	991257-03
Filament, pack of 5	EV-PS-SPK-3000	992610
Anode	EV-FIL-3000	991929
Beam former	EV-A-3000	991922
Beam former insulator	EV-BF-3000	990529
High voltage insulator	EV-IBF-3000	991921
Emitter rebuild kit <sup>1</sup>	EV-IHF-3000	993410
Crucible seal rebuild kit	ERK-MS	993439
Gasket 3.18mm VCR	CSRK-MS	042064
Filament clamp sleeve	EV-CRA-8VCR-SS	993415

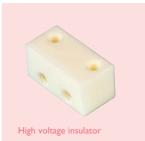
- <sup>1</sup> Includes two filaments, high voltage insulator, beam former and fasteners
- \* MS indicates Mighty Source  $^{\!\scriptscriptstyle\mathsf{TM}}$





















#### **Individual source**

#### **Description**

Caburn-MDC modular e-VAP® sources are state-of-the-art electron beam evaporation sources designed for the demanding and exacting world of vacuum coatings. This unprecedented selection of electron-beam evaporation sources provides vacuum coating solutions for most applications including medical, metallurgical, telecommunications, micro electronics and optics.

Modular sources are offered in six standard frame sizes and are stand alone components for maximum installation flexibility in existing vacuum systems. For those desiring standard, off-the-shelf solutions, complete horizontal and vertical flange-mounted systems are also available.

Modular sources are fitted with direct, water-cooled crucibles. Select modules have indirectly cooled crucibles that allow the user to change crucibles without interrupting the flow of water to the source and without having to disassemble the source. Modular sources are offered with material capacities from 6cc to 400cc in a multitude of pocket geometries and arrangements. They are available in both fixed and rotary pocket mechanisms for high and ultra-high vacuum environments. e-Vap® modular sources are designed for optimum performance with e-Vap® power supplies, controls and electronics. Other essential components and hardware required for the installation of e-Vap® modular sources are detailed starting on page 582. Contact your local technical sales office for custom electron-beam evaporation solutions to meet your needs.

#### **Features**

#### Filament assembly

- Filament is shielded from ion bombardment
- No shorting
- Longer filament life
- Reduced coating of ceramic insulators
- Reduced arcing

#### **Emitter assembly**

- 270° arc emitter module
- Heat sunk emitter
- Consistent electrostatic field
- Longer life anode and beam former
- Reduced filament distortion
- Modular plug-in assembly unit
- Simple maintenance
- Simple filament replacement
- Minimal adjustment only requires verification of filament tolerance

#### Open cathode design

- No space charging
- Increased emission
- Cooler operating filament, requires only 42A for I5kW

#### Shielded high voltage ceramics

- Reduces coating of ceramic insulators
- Prevents arcing
- Unique high voltage insulator design no screws to reduce dielectric breakdown

#### Beam sweep coil assembly

- Helmholtz design principle produces a uniform magnetic field
- No tunnelling
- Beam maintains constant density and shape when swept across crucible

#### Magnet assembly

- Permanent magnets
- 270° arc beam deflection with positive beam containment
- Reliable beam positioning
- No pole pieces
- Efficient magnetic field generation
- Beam travels vertically through crucible

#### Crucible module / replaceable modules

- Capacity from 6cc to 400cc
- Complete flush-top design
- No condensate build up
- No contamination from flaking condensate
- Complete utilization of vapour cone during deposition no shadowing
- Reduced cross-contamination during changes of evaporant material



Section 8.3

# **Modular evaporation sources**

#### Custom sources and assemblies



#### **Features**

#### **Custom source and source assemblies**

- Six frame sizes
- Single, multi-pocket or carousel crucibles
- Custom crucible configurations available
- Crucible sizes from 6cc to 400cc
- Power ratings from 6kW to 15kW
- Direct or indirect water cooling

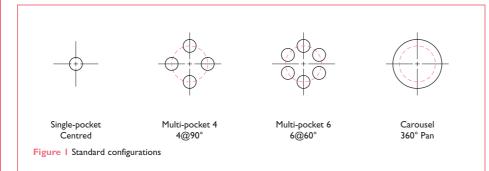
#### **Description**

Custom source and source assemblies can be designed to fit an existing chamber of for a special application. Contact your local sales office for details regarding custom source assemblies or custom sources.

#### **Options**

- **Source options** are available, consult your local sales office for existing designs, availability and prices
- Single pocket sources Frame I and 2 UHV-compatible sources, volumes 7 to 100cc
- **UHV rotary mechanism** Frame 4 and 5 allow for UHV operation of the multi-pocket sources
- Direct and indirect cooling Frame 5 and 6 option for both of these frame sizes. Direct cooling allows for higher power levels to be applied during deposition, the water seal must be disturbed to change the crucible. Indirect cooling allows the crucible to be removed without disturbing the water-to-vacuum seal, however maximum power levels are lower with indirect cooling.
- Custom crucibles can be machined with various pocket sizes and configurations depending on your application. Caburn-MDC will manufacture any custom crucible that is required including single, four-pocket, six-pocket, pan-carousel and bananas.

#### Crucible / pocket geometry



Combination-B 1x270°, 1@45° 1x90°, 2@90° Figure 2 Custom configurations

Standard, multi-pocket sources that have been identified by our customers as the most popular sources are listed to the right. Caburn-MDC has made a commitment with subcomponent inventory to offer reduced lead times for standard multi-pocket sources.

Frame size	Number of pockets	Volume per pocket	Maximum power
3	4	6cc	6kW
4	4	6cc	6kW
5	4	15cc	I0kW
5	4	25cc	I0kW
5	6	I2cc	10kW
5	1	150cc	10kW
6	4	40cc	15kW
6	4	75cc	15kW
6	1	400cc	15kW
6	6	40cc	15kW

Reference	Part number
EV-4000-66	991600
EV-4000-66UHV	991700
EV-4000-1015	991900
EV-4000-1025	991800
EV-6000-1012	992100
EV-4000-150CAR	992523
EV-4000-1540	992405
EV-4000-1575	992406
EV-4000-400CAR	993101
EV-6000-1540	993100







#### Custom sources and assemblies

#### Frame I

### **Specifications**

•		
Source size		Small
Source type		Fixed pocket
Maximum power		15kW
Operating voltage		6kV to 10kV
Filament		12V AC
Crucible geometry		Single-pocket
Crucible volume		7, 15, 25 and 40cc
XY sweep frequency		200Hz
Evaporation rate of a	aluminium	50,000Å/min @ 14kW with a source to substrate distance of 250mm
Beam spot size		7mm
Crucible material		OFE Copper
Bakeout temperatur	e	200°C
Materials		UHV compatible
Compatible vacuum		2×10-11 Torr
Water flow	3gpm and/or	65psig inlet/outlet differential
Dimensions		1681 × 124w × 53h
		4kg

## Small / fixed-pocket



Crucible volume	Maximum power	Reference	Part number
7cc	6kW	EV-1000-67	990598
15cc	10kW	EV-1000-1015	990599
25cc	10kW	EV-1000-1025	990597
40cc	15kW	EV-1000-1540	990600

#### Frame 2

#### **Specifications**

Source size		Large
Source type		Fixed pocket
Maximum power		15kW
Operating voltage		6kV to 10kV
Filament		12V AC
Crucible geometry		Single-pocket
Crucible volume		75 and 100cc
XY sweep frequency		200Hz
Evaporation rate of a	aluminium	50,000Å/min @ 15kW with a source to substrate distance of 250mm
Beam spot size		7mm
Crucible material		OFHC Copper
Bakeout temperatur	e	200°C
Materials		UHV Compatible
Compatible vacuum		2×10-11 Torr
Water flow	3gpm and/o	r 65psig inlet/outlet differential
Dimensions		1681 x 140w x 57h
Weight		4.5kg

## Large / fixed-pocket



Crucible volume	Maximum power	Reference	Part number
75cc	15kW	EV-1000-1575	992250
100cc	15kW	EV-1000-15100	992430



# **Modular evaporation sources**

#### Custom sources and assemblies

#### Frame 3

#### **Specifications**

Section 8.3

•	
Source size	Small
Source type	Rotary pocket
Maximum power	6kW
Operating voltage	6kV to 10kV
Filament	12V AC
Crucible geometry / volume	
Multi-pocket	4x 6cc, 6x 3cc
Carousel	360°, 15cc
XY sweep frequency	200Hz
Evaporation rate of aluminium	8,000Å/min @ 6kW
	with a source to substrate
	distance of 250mm
Beam spot size	7mm
Crucible material	OFHC Copper
<b>Bakeout temperature</b>	150°C
Materials	HV compatible
Compatible vacuum	2×10-8 Torr
Water flow 2gpm and/or 6	55psig inlet/outlet differential
Dimensions	1351 x 130w x 62h
Weight	4.5kg

## Small / rotary-pocket



Crucible volume	Maximum power	Reference	Part number
4 x 6cc	6kW	EV-4000-66	991600
6 x 3cc	6kW	EV-6000-66	992166

#### Frame 4

#### **Specifications**

•		
Source size		Small
Source type		UHV Rotary pocket
Maximum power		6kW
Operating voltage		6kV to 10kV
Filament		12V AC
Crucible geometry		Multi-pocket
Crucible volume		4 × 6cc
XY sweep frequenc	у	200Hz
Evaporation rate of	aluminium	8,000Å/min @ 15kW with a source to substrate distance of 250mm
Beam spot size		7mm
Crucible material		OFHC Copper
Bakeout temperatu	ire	200°C
Materials		UHV Compatible
Compatible vacuun	n	2×10-11 Torr
Water flow	1.75gpm and/or	65psig inlet/outlet differential
Dimensions		2121 × 136w × 85h
Weight		

#### Large / UHV rotary-pocket



volume 4 x 6cc	Maximum power 6kW	Reference EV-4000-66UHV	number 991700
Crucible	Maximum		Part



Custom sources and assemblies

#### Frame 5

#### **Specifications**

Source size	Large
Source type	HV Rotary pocket
	UHV Rotary pocket
Maximum power	IOkW
Operating voltage	6kV to 10kV
Filament	12V AC
Crucible geometry / volume	
Multi-pocket	4x 15, 25, 30cc and 6x 12cc
Carousel	360° 150cc
Combination	Custom designs available
XY Sweep frequency	200Hz
Evaporation rate of aluminium	30,000Å/min @ 10kW
	with a source to substrate
	distance of 250mm
Beam spot size	7mm
Crucible material	OFE Copper

#### Large / HV and UHV rotary-pocket



Crucible volume	Maximum power	Cooling	Reference	Part number
4 x 15cc	10kW	Direct	EV-4000-1050	991900
4 x 15cc	10kW	Direct	EV-4000-1015UHV	992700
4 x 25cc	10kW	Direct	EV-4000-1025	991800
4 x 30cc	10kW	Direct	EV-4000-1030	992408
6 x 12cc	10kW	Direct	EV-6000-1012	992100
4 x 15cc	6kW	Indirect	EV-4000-615i	992525
4 x 25cc	6kW	Indirect	EV-4000-625i	992500
4 x 30cc	6kW	Indirect	EV-4000-630i	992585
I x 150cc	6kW	Indirect	EV-4000-150CARi	992502
I x 150cc	10kW	Direct	EV-4000-150CAR	992523

#### Frame 6

#### **Specifications**

**Bakeout temperature** 

Compatible vacuum

**Materials** 

Water flow

**Dimensions** 

Weight

Source size	Extra-large
Source type	Rotary pocket
Maximum power	15kW
Operating voltage	6kV to 10kV
Filament	12V AC
Crucible geometry / volume	
Multi-pocket	4x 40, 60 and 75cc and 6x 40cc
Carousel	360° 400cc
Combination	Custom designs available
XY sweep frequency	200Hz
<b>Evaporation rate of aluminium</b>	n 50,000Å/min @ 15kW
	with a source to substrate
	distance of 250mm
Beam spot size	7mm
Crucible material	OFE Copper
Bakeout temperature	150°C
Materials	HV Compatible

#### Extra large / rotary-pocket

150°C

12kg

**HV** Compatible

157 x 143w x 82h

3gpm and/or 65psig inlet/outlet differential

2×10<sup>-8</sup> Torr

2×10-8 Torr

18kg

 $216l \times 174w \times 89h$ 

3gpm and/or 65psig inlet/outlet differential



Crucible volume	Maximum power	Cooling	Reference	Part number
4 x 40cc	15kW	Direct	EV-4000-1540	992405
4 x 60cc	15kW	Direct	EV-4000-1560	992400
4 x 75cc	15kW	Direct	EV-4000-1575	992406
6 x 25cc	15kW	Direct	EV-4000-1525	992599
6 x 40cc	15kW	Direct	EV-6000-1540	993100
I x 400cc	6kW	Indirect	EV-4000-400CARi	992720
I x 400cc	15kW	Direct	EV-4000-400CAR	993101
6 x 40cc	6kW	Indirect	EV-6000-640i	992674



Water flow

**Dimensions** 

Weight

Compatible vacuum

All dimensions are nominal in millimetres unless specified Weights given are approximate

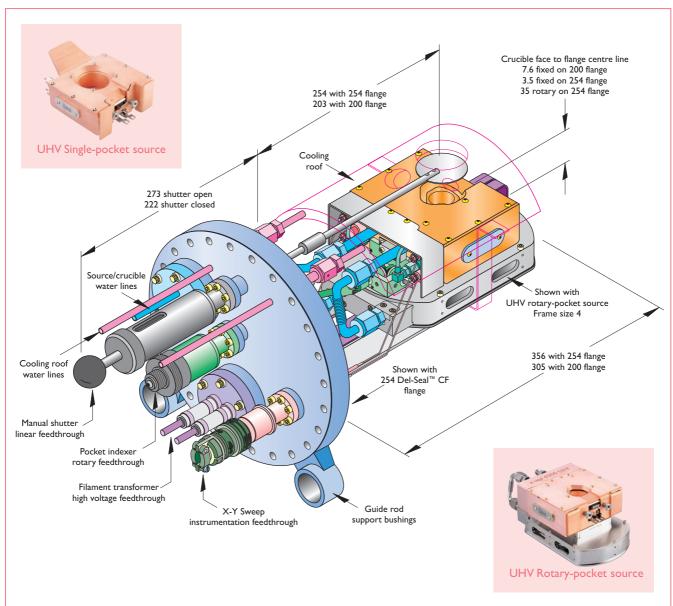


#### Horizontal source assembly



#### **Features**

- UHV-compatible system
- 200 or 254mm Del-Seal™ CF flange mount
- Assembly includes rotary, linear and electrical feedthroughs, clamps, linkages, water flow switch and water connections
- Manual, push/pull shutter
- High-temperature (300°C) manual rotary drive on fourpocket models; blanked off on single-pocket
- Flange seal surface to crucible centreline is 203mm on a 200mm Del-Seal™ CF
- Systems available with or without water-cooled roofs





Horizontal source assembly

# Horizontal flange-mounted

Caburn-MDC has eliminated the difficulties of flange mounting electron beam sources. Problems associated with designing and fitting sources into coating systems have been solved with the introduction of standard, horizontal flange-mounted evaporation sources. The compact footprint of these flanged evaporation systems allows installation of up to three individual sources onto one 254mm chamber. The flanged assemblies include an electron beam source with all water and electrical connections. A guide rod option provides a drawer-like sliding action, ideal for installation and system maintenance.

Horizontal flange-mounted assemblies come ready to accept this guide rod kit. Another option includes a water-cooled roof, which mounts directly above the e-Vap® source. The water-cooled roof acts as a heat barrier between the source and substrate and also prevents vapour condensation on chamber walls. The water-cooled roof is fitted with a deposition port, angled towards the substrate, which aids in deposition uniformity, even when source and substrate centrelines are offset. Horizontal systems purchased with a source control module will be fitted with flange-mounted filament transformers.

Description	Option Number
Pneumatic shutter, two position	-01
Auto indexer and drive	-02
Guide rods	-03
Custom source position	-04
Custom cooling roof ports	-05
15cc Crucible	-06
25cc Crucible	-07
40cc Crucible	-08

When ordering e-Vap® assembly options, please add the option number(s) to the end of the desired assembly part number listed on the opposite page

For example: 992515-01-02-03-04-05-08

#### **Optional accessories**

#### Option -01



#### Pneumatic shutter

Pneumatic shutters are an excellent tool for precise control of film thickness onto a substrate. The air actuated shutter masks off the vapour stream between source and substrate at the beginning and finishing stages of the evaporation/deposition cycle. The shutter also allows premelt or soak prior to deposition by blanketing the evaporation material. This is a two-position shutter with a 24V AC solenoid.

#### Option -02



#### Crucible indexer and driver

The Auto-Indexer is a stepper motor drive unit with optical encoding for rotating and positioning multi-pocket eVap® sources. The unit can drive sources up to eight pockets in either an unidirectional or bidirectional manner. It can also drive continuous carousel-type sources at eight speed settings. Includes mounting bracket for external drive.

#### Option -03



#### **Guide rods**

Two linear bearing guide rods allow the flange mounted e-Vap® systems to be routinely maintained by simply sliding in and out, in drawer-like fashion. A weldable support bracket kit is provided to secure the guide rods onto the user's port flange. Installation is simple and self explanatory.

#### Option -04 to -08



#### **Custom source position and volume**

The standard distance from the source centre to the mounting flange seal face is 254 or 203mm for horizontal systems. For custom positions, between 203 and 305mm add option 04. Standard, single-pocket crucible volume is 7cc. For pocket volumes of 15, 25 or 40cc, add option 06, 07 or 08 respectively.

#### Option -05



#### **Custom roof parts**

Water-cooled roofs have three ports. A main port directly over the source, which is used for the deposition process. A second port for the crystal sensor is used to monitor the deposition rate. A third port provides direct visual inspection of the source and beam through a chamber viewport. Each of these port locations can be specified by the customer.

Mounting flange	Frame size	Source type/ volume	Cooling roof	Source number	Wt. kg	Reference	Part number
200 Del-Seal™	1	One-pocket, 7cc	No	990598	23	EV-FMP-8H	992515
200 Del-Seal™	1	One-pocket, 7cc	Yes	990598	23	EV-FMP-8RH	992516
254 Del-Seal™	1	One-pocket, 7cc	No	990598	34	EV-FMP-10H	992499
254 Del-Seal™	1	One-pocket, 7cc	Yes	990598	34	EV-FMP-10RH	992541
254 Del-Seal™	4	Four-pocket, 6cc	No	991700	43	EV-FMP-10HUHV	992498
254 Del-Seal™	4	Four-pocket, 6cc	Yes	991700	43	EV-FMP-10RHUHV	992540



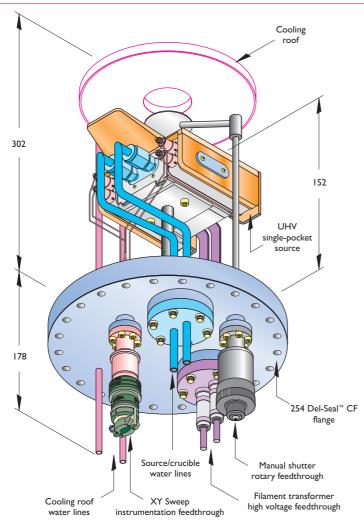


Vertical source assembly



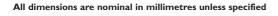
#### **Features**

- UHV-compatible system
- 254mm Del-Seal™ CF flange mount
- Assembly includes rotary, linear and electrical feedthroughs, clamps, linkages, water flow switch and water connections
- Shutter is fitted with a high-temperature (300°C) manual rotary drive
- Flange seal surface to crucible centreline is 152mm as standard
- Systems available with or without water-cooled roofs













Vertical source assembly

#### **Vertical flange-mounted source**

Caburn-MDC has eliminated the difficulties of flange mounting electron beam sources. The effort that goes into designing and fitting a source to a vacuum coating chamber has been done for you with the introduction of standard, vertical flangemounted evaporation sources. The flanged assembly includes one 7cc electron beam source with all water and electrical connections.

This type of flange-mounted system is typically installed vertically through the bottom side of a chamber. The compact footprint of these flanged evaporation systems requires only one port flange for installation. A popular option commonly ordered with these systems is a water-cooled roof, which mounts directly above the e-Vap® source. The water-cooled roof acts as a heat barrier between the source and substrate, as well as preventing vapour condensation on chamber walls.

The water-cooled roof is fitted with a deposition port, angled towards the substrate, which yields excellent deposition uniformity, even when source to substrate centrelines are offset.

The single-pocket source comes standard with a 7cc capacity crucible. The same assembly can be fitted with larger capacity sources, including 15, 25 and 40cc versions. To order the larger volume crucible option, add the relevant option number to the end of the assembly part number.

Vertical systems purchased with a sourcecontrol module will be fitted with flangemounted filament transformers.

Description	Option number
Pneumatic shutter, two position	-01
Custom source position	-04
Custom cooling roof ports	-05
I5cc Crucible	-06
25cc Crucible	-07
40cc Crucible	-08

When ordering e-Vap® assembly options, please add the option number(s) to the end of the desired assembly part number listed below

For example: 9925 | 5-0 | -02-03-04-05-08

#### **Optional accessories**

#### Option -0



#### Pneumatic shutter

Shutters mask off the vapour stream between the source and substrate. Shutters are ideal for pre-melt or soak prior to deposition by blanketing the evaporation material. Pneumatic shutters for vertical flanged assemblies cannot be mounted on source flange, but can be installed through a secondary 34mm Del-Seal To CF port. This shutter is a two-position shutter which includes a 24V AC solenoid.

#### Option -04



#### **Custom source position**

Source position is the distance from the source face to mounting flange seal face. This dimension is standard at 152mm for all vertical systems.

Customer chamber layout of specifications may dictate a custom distance. Source positions between 152 and 254mm are optional and pricing information for these is available from your local sales office.

#### Option -05



#### **Custom roof parts**

Two linear-bearing guide rods allow the flange-mounted e-Vap® systems to be routinely maintained by simply sliding in and out, in drawer-like fashion. A weldable support bracket kit is provided to secure the guide rods onto the user's port flange. Installation is simple and self explanatory.

#### Option -06 to -08



#### **Custom crucible volume**

The standard volume for a single-pocket crucible is 7cc. For single-pocket volumes of 15, 25 or 40cc, add the relevant option listed to the right.

Mounting flange	Frame size	Source type/ volume	Cooling roof	Source number	Wt. kg	Reference	Part number
254 Del-Seal™	1	One-pocket, 7cc	No	990598	23	EV-FMP-10V	992511
254 Del-Seal™	I	One-pocket, 7cc	Yes	990598	23	EV-FMP-IORV	992513





#### Power supplies



#### **Features**

- 6kW, 10kW and 15kW models
- High-frequency switching technology
- Excellent regulation
- Low stored energy
- Power efficiency greater than 85%
- Low ripple
- Rugged IGBT switches
- CE compliant
- Sequential or simultaneous operation of up to three electron beam evaporation sources

#### **Specifications**

Metering	Digital voltage and emission	on current
Cooling	/	Air cooled
Input power	$208V \pm 10\%$ , three-phase, 50/60Hz, 30 400V $\pm$ 5%, three-phase, 50/60Hz, 15	
Voltage Output Ripple Regulation Efficiency	I to I0kVDC, negative less that ±0.25% of full-sca	n I% RMS
Cables Input power cord 8-gauge ground w	1 117	<b>Length</b> 3.66m 3.66m
Current output: 6kW 10kW 15kW	0 to 0.6A 0 to 1.0A 0 to 1.5A	
Dimensions	483w × 26	50h × 5331

Power supply	Voltage	Wt. kg	Reference	Part number
6KW	208	34	CVS-6-2CE	991240
10KW	208	41	CVS-10-2CE	991275
15KW	208	45	CVS-15-2CE	991242
6KW	400	34	CVS-6-4CE	991193
10KW	400	41	CVS-10-4CE	991245
15KW	400	45	CVS-15-4CE	991246

e-Vap® CVS series power supplies are constructed using state-of-the-art, solid-state, high-frequency switching technology. They are offered in three standard models, rated for 6kW, 10kW and 15kW. CVS series power supplies are for use with the horizontal and vertical flange-mounted systems detailed on the previous four pages, as well as the e-Vap® modular sources as detailed in the opening pages of this section. These power supplies are also compatible with most commercially available electron beam sources and are recommended as upgrade power supplies in existing electron beam evaporation systems.

Power supply enclosures are fully interlocked for operator safety. e-Vap® CVS series power supplies can power and control up to three electron beam sources. Source controls and XY sweeps are not included with power supplies and must be purchased separately.

The e-Vap® source control module also employs solid-state, high-frequency switching technology and is designed to precisely control emission current when used with e-Vap® power supplies. MDC recommends the use of a high-voltage grounding hook when servicing or working with all high-voltage power supplies. Grounding hooks are detailed in this catalogue on page 592.



see the table below for weights



#### Source control module



#### Source control module





#### **Specifications**

Metering	Digital emission	current
Cooling	Air	cooled
Input power	220V ± 10%, single-phase, 50/60	)Hz, 8A
Voltage Output Efficiency	ı	12V AC 85%
Current output	0	to 70A
Cables	From-To	Length
Input power cord Interface cable <sup>1</sup>	Wall outlet/source control module Power supply/source control module	2.3m 1.8m
Secondary cable	Transformer/e-Vap® source	0.9m
Control cable <sup>2</sup>	Source control module/transformer	3.6m
Transformer input cable <sup>2</sup>	Source control module/transformer	3.6m
High voltage cable <sup>2</sup>	Power supply/transformer	3.6m
Dimensions	216w × 133h	n × 356l
Weight		9kg

- 1 Fixed-length cables; not available in other lengths
- <sup>2</sup> A 7.62m cable kit may be purchased separately; three cables are included per kit

Description	Wt kg	Reference	Part number
Direct package	4.5	SCM-DFM-CE	991364-01
remote package	4.5	SCM2-RCM-CE	991364
Remote mount with 2 x 25mm bolt	4.5	SCM2-RCM-CE	991364-02
Half-rack spacer	.57	EV-HRS	991062
7.62m cable kit	1.42	SCM-25FC-CE	991287

#### Source control module

#### **Features**

- High-frequency switching technology
- Improved emission stability over 60Hz SCR circuits
- Compact filament transformer
- Electrically isolated from high-voltage unit
- Grounded and shielded filament transformer offers improved safety over conventional designs
- Self-contained emission current monitoring for independent operation
- CE compliant
- Full remote control capability
- Touch screen programming
- PS/2 hand-held mouse/trackball
- Rack mount brackets included

e-Vap® CVS source control modules are designed for use with e-Vap® CVS series power supplies. The source control module unit includes filament transformer assembly, hand-held mouse control and all necessary cables for hook up with an e-Vap® CVS power supply. A maximum output current of 70A assures sufficient power to drive virtually any commercially-available electron beam source.

e-Vap® CVS source control modules are available in three installation packages, direct flange mount and two remote cable mounts. Direct flange mount packages are used on all Caburn-MDC flange mounted evaporation systems. This package allows mounting of the filament transformer to a high-voltage feedthrough fitted with a 70mm Del-Seal™ CF flange. Filament transformer attachment is accomplished by bolting the transformer housing via two of the flange's .250-28 bolts positioned 180° apart.

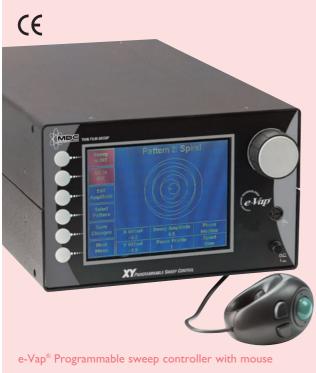
The remote cable mount packages provide 914mm of high-voltage cable with OFE copper connector lugs and an acrylic high-voltage shield. This package is typically used with modular source installations where highvoltage electrical feedthroughs are fitted with 70mm Del-Seal™ CF flanges, but limited space does not allow direct installation. The second remote package is used on installations where high voltage are two 25mm feedthroughs.

The source control module's compact size occupies only half the width of a standard 483mm electronics rack. To facilitate the installation into a standard 483mm electronics rack, Caburn-MDC offers half-rack spacers. However, if the source control module is purchased in conjunction with an e-Vap® programmable XY sweep controller, the two units can be fastened together to form the standard 483mm rack width, thus eliminating the need for a spacer.



All dimensions are nominal in millimetres unless specified Weights given are approximate

XY Programmable sweep controller



Section 8.4

#### **Description**

The next-generation e-Vap® programmable sweep controller has taken electron beam sweep capabilities to a higher level in versatility and practicality. It combines years of customer feedback with the latest advances in electronics technology. It possesses profound advancements from its predecessor in terms of functionality and ruggedness. It is designed with both the coating engineer and coating operator in mind.

Electron beam control is dynamically precise, allowing the user optimum ability to deposit dielectrics and metals in the most demanding of applications. The strength of the sweep controller lies in its ability to easily adapt to different evaporation process requirements, using its many expandable sweep patterns.

Four predefined sweep patterns and up to 95 user-defined patterns may consist of up to 208 XY points with a different beam dwell time for each beam point. The user interface includes a large, vibrant colour LCD display with six function keys and a smooth rolling adjustment knob.

A hand-held PS/2 device (trackball) is provided, allowing beam manoeuvrability for crucible material preparation and evaporation. For computer-automated vacuum systems, a detailed rear panel digital I/O port, along with a standard RS-232 interface, allowing access to the most important sweeper functions and status signals. An optional interactive Windows® programme is available allowing desktop sweep pattern design and virtually unlimited sweep pattern storage.

#### **Features**

- Use with virtually any electron beam source
- Large colour LCD display
- Store up to 99 sweep patterns (95 user programmable)
- PS/2 hand-held mouse/trackball control included
- An audible alarm warns of possible fault conditions
- Ability to custom name each sweep pattern
- Ability to choose a crucible pocket number to correspond to specific sweep patterns and/or parameters such as beam centring or evaporation material specification.
- Ability to custom name the sweep controller itself for coating machine identification
- Expanded beam power profile capabilities allow the user to control erosion of difficult-to-evaporate materials
- Customizable display colour (foreground and background) to match your company colours or coating machine colours
- Password option requires a four-digit code to access functions
- RS-232 interface
- Safety interlocked
- All cabling included
- CE compliant
- Rack mounting brackets included

#### **Specifications**

Graphic display	Colour LCD
Input power	100-200/200-240V, 50/60Hz, 3A
Max coil output Sweep + DC	bias 5A
Max sweep frequency	200Hz
Programming interface	Push-button, digital I/O or RS-232
Mouse remote input	PS/2
Max cable length 18AWG	7.62M
Weight	5kg
Dimensions	216w × 133h × 356w





# Total South South

#### XY Programmable sweep controller

#### Sweep pattern types

All of these patterns may have their sweep characteristics and parameters highly modified. These parameters include speed, phase and power profile.

Speed is defined as the speed at which the beam travels to complete one cycle of a given pattern. The fundamental frequency of beam sweep is speed. Speed settings are fast, medium and slow. Fast is considered the base time, medium takes twice as long and slow takes five times longer.

PHASE is defined as angular pattern rotation per cycle. The pattern is rotated a few degrees after each sweep pattern cycle. PHASE settings are fast (50 degree steps), medium (20 degree steps), slow (10 degree steps) and none.

#### **S**elect pattern

Main Screen	MDC Sweeper Pattern 5	
Prev Menu	Scroll Patterns with Knob	A
Edit Points	1. Pattern 1 Circle 2. Pattern 2 Spiral 3. Pattern 3 Figure 8	ı
Edit Params	4. Pattern 4 Line 5. Pattern 5 User 6. Pattern 6 User	
Edit Name	7. Pattern 7 User 8. Pattern 8 User 9. Pattern 9 User	
Delete Pattern	10. Pattern 10 User 11. Pattern 11 User	v

The select pattern screen allows the user to view patterns one through 99. All patterns may be started and/or edited from this screen as well.

#### Spiral pattern

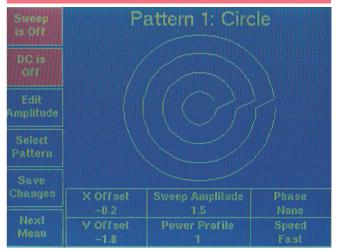
Sweep is Off	Pa	attern 2: Spir	al
DC is Off			
Edit Amplitude			
Select Pattern			
Save			
Changes	X Offset -0.2	Sweep Amplitude 0.5	Phase Medium
Next Menu	V Offset −1.8	Power Profile	Speed Slow

A spiral pattern makes the beam sweep in a continuous spiral, beginning at the outer edge of the crucible and advancing toward the centre and then back out again.

Power profile is defined as the speed of the beam based on its distance from the centre of the crucible. It allows the beam to sweep faster through the centre of the crucible than at the outer edges. The parameter of a pattern crossing the crucible too many times, thus resulting in tunnelling of the material, may be adjusted to obtain even beam temperature distribution across the crucible surface. Power profile settings range from 1 to 1/R². A setting of 1 is considered as the beam dwell time being the same for all points. a setting of 1/R² is considered the beam dwell time being four times greater on the outer edges of the crucible. Adjusting the profile between 1 and 1/R² (20 possible adjustments) is a new feature for the sweep controller and adds coating process optimization to this

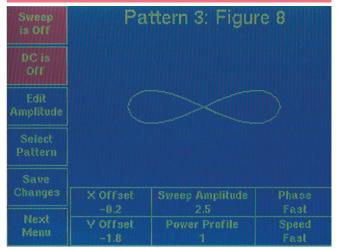
#### Circle pattern

already valuable parameter.

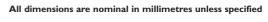


The circle pattern makes the beam sweep in concentric circles beginning at the outer edge of the crucible and steps closer to the centre of the crucible with each revolution. Upon reaching the centre, a reverse cycle begins and the beam sweep pattern continues.

#### The figure-eight pattern



The figure-eight pattern makes the beam sweep in a well-defined figure-eight path across the crucible.





## **Controls and measurement**

XY Programmable sweep controller

#### Sweep pattern types

Section 8.4

Line pat	tern		
Sweep is Off	P	attern 4: L	.ine
DC is Off			
Edit Amplitude			
Select Pattern			
Save			
Changes	X Offset		le Phase Medium
Next	-0.2 V Offset	3.5 Power Profile	
Menu	-1.8	1	Medium

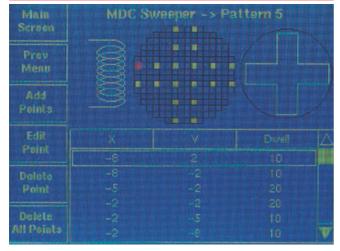
A line pattern makes the beam sweep in a straight line across the crucible. As in all the predefined patterns (circle, spiral, figure eight and line), the sweep amplitude, speed, phase, power profile and XY offset can be readily adjusted. There is also easy access to selecting patterns and scrolling through different screen

#### System parameters

Main Screen	MDC Sweeper Pattern 5		
Prev Menu	Parameter		$\Box$
	X Offset	-0.2	
Edit			TH
Eult	Gun Type		
	Linear Amplitude		
	Linear Rotation		
	Contrast		
	Foreground Color	Yellow	
	Background Color		
	Maximum Amplitude		
	Machine Name	MDC Sweeper	
	Mouse Sensitivity	10	V

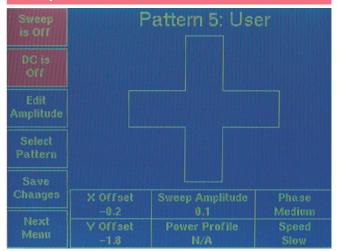
The system parameter screen allows the XY offset to be adjusted and stored. Linearity and contrast adjustments can be implemented from here as well. Foreground and background colour selections can also be made from this screen and will affect all subsequent patterns. The maximum allowable sweep amplitude current can be set here for the pattern. You can also designate the coating machine's name, as well as adjust the sensitivity of the mouse from this screen.

#### User pattern



User pattern: 95 user-defined patterns, completely Customizable by the user, can be designed and stored into the sweep controller for instant access. Each of the userdefined patterns can contain up to 208 beam location points. Each point can possess its own dwell time ranging from I to 100mS. Patterns can be designed via the front panel of through RS-232. If designed via the front panel, a colour, interactive-matrix panel is displayed for user feedback.

#### User pattern



It displays a crucible-shaped area showing all selected points (see the interactive matrix panel shown on the left). Custom naming of the generated pattern, adding and deleting points/patterns and modifying dwell times can all be done on the same screen. A new feature of the sweep controller allows the user to access the speed function as well. Choices for the speed setting are fast, medium and slow.

XY Programmable control sweeper



The sweep controller has the ability to custom name each individual sweep pattern, whether pre-defined or user-defined. For example, when you choose a specific pattern for a specific evaporation material, it may be desirable to name th pattern after the evaporation material, such as OuartzPattern or TitaniumPattern.

The sweep controller also has the ability to store a name for itself. If your coating machine is called Coating Machine One you can customise the name of the sweep controller as CoatingMachineOne.

The sweep controller also has the ability to assign a specific pattern number I to 99 to a specific crucible number or pocket. This is advantageous for users who always have a certain evaporation material in a certain crucible pocket. This allows the user to save custom sweep and beam parameters for a given crucible pocket. This is beneficial since most deposition controllers have the ability to invoke crucible pockets during a coating cycle.

#### Handheld PS/2 mouse/trackball



The XY programmable sweep controller comes equipped with a hand-held PS/2 mouse/trackball which allows activation and XY offsets and sweep amplitude adjustments from up to 1.8m away.

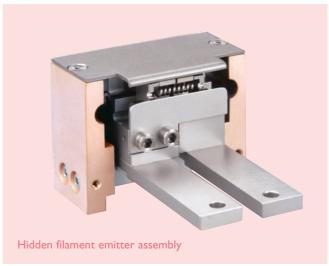
#### **Functions**

Sweep on/off
 DC on/off
 click left mouse button
 click right mouse button
 roll the trackball in the desired direction

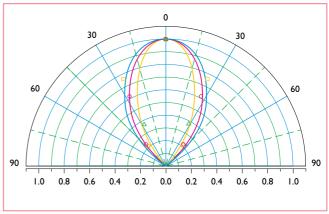
Edit amplitude
 highlight amplitude and roll trackball up or down

#### **Optical coating uniformity solutions**





# Maximized coating distribution with optimal sweep patterns



Description	Reference	Part number
XY programmable sweep controller	XYS2-CE	991344
Half-rack spacer	EV-HRS	991062

All dimensions are nominal in millimetres unless specified



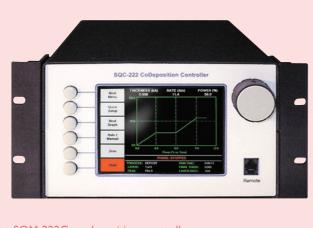


#### Deposition monitoring and control



#### **Description**

Caburn-MDC offers a choice of four units with a range of capabilities from monitoring the deposition process to controlling multiple deposition processes or controlling co deposition processes. The choices are tailored from introductory/economical thin film deposition to full process control for a production process. co deposition of materials from multiple sources allows easier fabrication and investigation of complex material compositions and layers. All of the monitors and controllers utilise proven 6MHz quartz crystal sensor technology to measure the thin film deposition process.



SQM-222C co deposition controller

#### **SQM-160**

The SQM-160 measures thickness and deposition rate of the thin film deposition process. The base unit can monitor from two independent measurement channels. Four relays are available to control source and crystal shutters during the deposition process. Up to nine films can be stored in memory the SQM-160's memory, active film can be easily changed from the front panel. All parameters can also be set from the front panel of the monitor. The SQM-160 is a monitor only and is not capable of controlling the rate during deposition.



SQM-122C two-channel deposition controller

#### **SQC-122**

The SQC-122 controls deposition rate and thickness in multilayer thin film deposition processes. The controller was designed for ease of use with six content sensitive softkeys, providing rapid access to frequently used data. The 122C memory will hold up to 25 processes, consisting of 250 layers and 25 materials. Cut, copy and paste capabilities make it easy to modify or duplicate processes and layers. The controller has inputs for two crystal sensors, two 0 to 10V outputs are available to control the evaporation rate. Eight relays and digital inputs can be independently assigned to over 40 possible events, including pocket rotation and external process controls. A Windows® programme for setup and data acquisition is also included with the controller.



#### **SQC-222C**

The SQC-222C model of the controller includes software for co deposition control. The two crystal sensors and two outputs to control the deposition rate, along with special software features, allow for co deposition capability.

All dimensions are nominal in millimetres unless specified Weights given are approximate

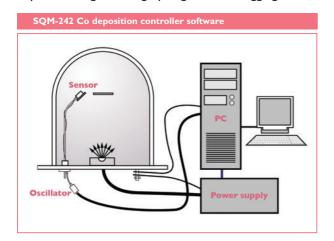




#### Deposition monitoring and control

#### **SOM-242**

The SQM-242 is a thin film deposition controller and a standard PCI expansion card. Each SQM monitors from one to four crystal sensor inputs, and provides two control voltage outputs. A typical single-sensor deposition system is shown, the SQM-242 card is installed in a computer, a quarts crystal sensor is connected to the input and the output is connected to a power supply. The card will control the deposition rate and adjust the output of the power supply for constant deposition rate. The basic SQM-242 card includes software that is easily modified to communicate with digital I/O cards. The SQS-242 software package supports multiple cards, co deposition, digital I/O, graphing and data logging.





SQM-242 Co deposition controller PCI card

Description	Reference	Part number
SQM-160 2-Channel deposition monitor	SQM-160	991366
SQM-122C 2-Channel deposition monitor	SQM-122C	991309
SQM-222C 2-Channel deposition monitor	SQM-222C	991367
SQM-242 2-Channel deposition monitor	SQM-242	991327
SQS-242 Co deposition software	SQS-242	991328

#### Crystal sensor packages



Low-profile sensor packages include a sensor head, oscillator, 762mm in-vacuum cable, 152mm BNC cable, 254mm BNC cable, a box of five gold-coated sensor crystals, two Swagelok® compression fittings and a 25mm baseplate sensor feedthrough . Bakeable to 180°C.



Low-profile sensor packages include a sensor head, oscillator, 762mm in-vacuum cable, 152mm BNC cable, 254mm BNC cable, a box of five gold-coated sensor crystals, two Swagelok® compression fittings and a 70mm Del-Seal™ CF sensor feedthrough. Bakeable to 180°C.

<b>70mm Del-Seal™ CF</b> Bakeable to 400°C

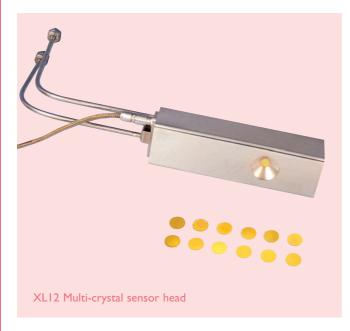
Bakeable sensor packages include a 400°C bakeable sensor head, oscillator, 762mm in-vacuum cable, 152mm BNC cable, 254mm BNC cable, and a box of five gold-coated sensor crystals. The sensor head is pre-installed on a 70mm Del-Seal™ CF flange, which includes the sensor feedthrough.

		Wt.		Part
Description	Mount	kg	Reference	number
Low-profile sensor pack	25mm baseplate	2.3	LSP-I	991310
Low-profile sensor pack	70mm Del-Seal™ CF	2.3	LPSP-275	991311
Bakeable sensor pack	70mm Del-Seal™ CF	2.3	LPSP-HT-275	991637
Sensor crystals, gold rated	Box of 10	2.3	CRP-500-117	991131





#### Deposition monitoring and control



Section 8.4

#### **Description**

The XL12 Multi-crystal sensor head can hold up to 12 6MHz crystals at one time. With the XL12, the customer can take financial advantage of longer deposition runs. This instrument is an exclusive, patent-pending design, ready to meet industry needs.

This revolutionary design is small sensor head, just  $38w \times 146l \times 35h$ , that uses slide technology to transfer the crystals. Crystals are seated in carriage assemblies in order to provide guaranteed exchange during process. When the crystal in use expires, an operator can manually signal the next crystal to move into position, or the operator can send a signal via the thin film monitor/controller. After a signal is given, the XLI2 transfers the next crystal into position and moves the expired crystal into a holding compartment.

To reload the XL12, you simply remove the self-aligning crystal cartridge from the main body. You then remove two screws and the top plate; reload with 12 new crystals; replace the top plate and screws; then, reinstall the cartridge to the main body. This process takes less than five minutes.

# Description Wt. kg Reference number XL12 Multi crystal sensor head 9 EV-XL12CS 991375

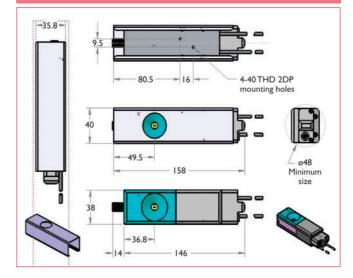
#### **Features**

- Reliable
- Small footprint
- Minimal shadowing
- Ease of installation
- Works with present Thin Film controllers
- One-third the price of leading competitors' units

#### XL12 Multi-crystal sensor head package

- Multi-crystal sensor head
- Controller
- 25mm Bolt feedthrough or 70mm Conflat®
- 762mm In-vacuum cable
- 12 Quartz crystals
- 15 Crystal carriages
- Two sensor shields

#### Figure 1 XL12 Multi-crystal sensor head specifications



#### Crystal loaded in cartridge







#### Crucible indexer



#### **Features**

- Direct drive no pulleys or belts to set or adjust
- Electronic calibration of position
- Eight predefined pocket configurations included
- User-configurable feature allows for custom or special pocket configurations
- Can be operated manually or by external controller
- Two speed ranges for a total of 20 speed settings
- 1.8° Resolution
- CE Compliant

#### **Description**

The e-Vap® crucible indexer is a microstepper-controlled motor drive unit used to position and rotate a multihearth electron beam source. The crucible indexer will rotate and position up to eight pocket positions; additionally, eight preprogrammed configurations can be selected via dip switch settings at the back of the controller.

These include: two-, four- and six-pocket, 180° banana, three-pocket 90° banana, three-pocket 120° banana, three-pocket 135° banana, three-pocket 145° banana and continuous 360° rotation.

An additional dip switch lets the user select the following modes: bi-direction (shortest path between pockets), counter-clockwise rotation, UHV source type, high speed range, BDC I/O, and enable ethernet communications. In addition, the indexer can be user-configured for any pocket/banana crucible layout. The indexer also eliminates mechanical adjustment of the home or first pocket location, the 'home' position can be defined electronically.

The e-Vap® crucible indexer can be controlled either manually or remotely, it can be configured to interface with most deposition controllers equipped to select pockets on a multilayer deposition. A Windows®-based configuration screen can be used to customise the pocket layout. The drive motor comes with a bracket to attach a 70mm Del-Seal™ rotary feedthrough or a 25mm bolt-type rotary feedthrough. The indexer is supplied with a coupling to connect the 6.35mm drive shaft to the 6.35mm feedthrough shaft. The e-Vap® crucible indexer is designed to be one of the most flexible methods to customise or fine tune crucible rotation and control for multihearth electron beam sources.

#### **Specifications**

#### **Motor drive**

Motor type		Micro-stepper
Torque		1.4N-m(200oz-in)
Speed RPM Low High		8, 0.10, .012, .015, .019, .024, 0.30, .037 .5, 0.6, 0.8, 1.0, 1.2, 1.5, 1.9, 2.4, 3.0, 3.7
Resolution		1.8°
Repeatabili	ty	0.25°
Size height x	width x depth	89 × 89 × 122
Weight		1.5kg
Power		12W
Controll	er	
Pockets		up to 8
Digital inpu Low High	ts	Binary or BCD-encoded 0 to 2V DC 4 to 24V DC, non-isolated
Communica	ations	RS-232 or Ethernet
Size height x	width x depth	88 × 213 × 197
Weight		2.7kg
Power		100-120/200-240V AC, 50/60Hz, 20W
Compliance	9	CE (LVF & ECD)
Interconnec	cting cable	3M standard DB25

Crucible indexer	EV-CI-INDEXER	991400
Description	Reference	Part number





Safety accessories and shutters

#### High-voltage safety accessories



Grounding hook Caburn-MDC recommends the use of a grounding hook prior to service or maintenance of any high-voltage equipment. Connections which were previously energised should be discharged with a grounding hook solidly connected to a low-impedance earth ground. Hook installation is made easy with the supplied 1.63M insulated cable.

High-voltage shield To prevent accidental contact with exposed high-voltage leads, Caburn-MDC recommends the use of high-voltage acrylic shields. These shields are available for both 70mm Del-Seal™ CF flange mounted and 25mm baseplate mounted feedthroughs. Strain relief will accept cables from 5.8 to 12mm in diameter.

Description	Reference	Part number
High-voltage safety ground hook	EV-SGH	991106
Acrylic shield, 70mm Del-Seal™	HVE-2	640051
Acrylic shield, 25mm baseplate	BHVE-2	640057

#### Pneumatic shutter Two-position



Pneumatic shutters are an excellent tool for precise control of thin film thickness onto a substrate. The air actuated shutter masks off the vapour stream between source and substrate at the beginning and finishing stages of the evaporation/deposition cycle. The shutter also allows pre-melt or 'soak' prior to deposition by blanketing the evaporation material. Shutters with a 50mm diameter and a 50mm stroke are used on sources with crucible volumes of less than 40cc. Shutters with a 75mm diameter and a 100mm stroke are used on sources with crucible volumes of 40cc and greater. These shutters come standard with a 120V AC solenoid valve.

Nominal flange	Shutter diameter	Stroke length	Reference	Part number
34	50	50	PS-2P2-133	991796-02
34	75	100	PS-2P3-133	991796-01
70	50	50	PS-2P2-275	991794-02
70	75	100	PS-2P3-275	991794-01

#### Pneumatic shutter Three-position



Three-position pneumatic shutters offer greater process flexibility than other shutters. In position one, the shutter will close the deposition and rate monitoring ports on a horizontal e-Vap® system fitted with a water-cooled roof. in position two, the shutter continues to block the deposition port, but opens the rate-monitoring port. In position three, all ports are open and the system is ready to begin a coating cycle. This shutter includes a I20V AC solenoid air control valve.

Description	Reference	Part number
Shutter Three-position	PS-3PW-133	996343

All dimensions are nominal in millimetres unless specified





#### Shutters, rods and switches

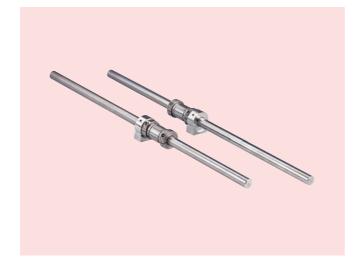
#### Manual shutter push-pull



Manual shutters are an excellent tool for control of thin film thickness onto a substrate. The manually-operated shutter masks off the vapour stream between source and substrate at the beginning and finishing stages of the evaporation/deposition cycle. The shutter also allows premelt or 'soak' prior to deposition by blanketing the evaporation material. Shutters with a 50mm diameter by 50mm stroke are used on sources with crucible volumes of less than 40cc. Shutters with a 75mm diameter by 100mm stroke are used on sources with crucible volumes of 40cc and greater.

Nominal flange	Shutter diameter	Stroke length	Reference	Part number
34	50	50	MS-2-133	991793-01
34	75	100	MS-3-133	991793-02
70	50	50	MS-2-275	991792-01
70	75	100	MS-3-275	991792-02

#### Linear guide rods



Linear bearing guide rods allow horizontal flange mounted e-Vap® systems to be routinely maintained by simply sliding in and out, in drawer-like fashion. Two linear ball bushings provide the smooth gliding action required for ease of movement. Weldable support brackets secure the guide rods onto the user's port flange. The bracket installation procedure is simple and self-explanatory.

Description	Reference	Part number
Description	Reference	number
Guide rods	EV-LGRA	991791

#### Water flow switch



e-Vap® electron beam sources rely on water-cooling to dissipate the large amounts of heat generated by an electron beam. Proper water flow is essential for normal system operation as well as for safety. The water flow switch will turn off all power to the e-Vap® source when and if a present water flow rate drops below its set point.

Description	Reference	Part number
Water flow switch 24V DC	EV-WF240	991031-01



#### Crucible liners

Section 8.5



We recommend using crucible liners with all e-Vap® sources. Crucible liners provide thermal isolation between a target material and a source's water-cooled crucible. These liners offer improved thermal stability while reducing the transfer of heat to the crucible. Liners provide the ability to easily and quickly switch evaporant materials without removing the source for cleaning. They also reduce power requirements to achieve specific evaporation rates. Graphite and vitreous carbon are the most popular liner materials, due to their low cost and favourable thermal properties. Vitreous carbon is produced using a patented glazing process, then baked above 1400°C to eliminate any porosity in the carbon.

Linear	Crucible		Part
material	size	Reference	number
Graphite	2cc	EV-CL2G	992584-01
Graphite	6cc	EV-CL6G	990586-01
Graphite	7cc	EV-CL7G	990587-01
Graphite	15cc	EV-CL15G	990588-01
Graphite	25cc	EV-CL25G	990589-01
Graphite	30cc	EV-CL30G	992484-01
Graphite	40cc	EV-CL40G	990590-01
Graphite	60cc	EV-CL60G	992571-01
Graphite	75cc	EV-CL75G	992572-01
Graphite	I00cc	EV-CL100G	992573-01
Vitreous carbon	2cc	EV-CL2VC	992584-02
			990586-02
Vitreous carbon	6cc	EV-CL6VC	990587-02
Vitreous carbon	7cc	EV-CL7VC	
Vitreous carbon	15cc	EV-CL15VC	990588-02
Vitreous carbon	25cc	EV-CL25VC	990589-02
Vitreous carbon	30cc	EV-CL30VC	992484-02
Vitreous carbon	40cc	EV-CL40VC	990590-02
Vitreous carbon	60cc	EV-CL60VC	992571-02
Vitreous carbon	75cc	EV-CL75VC	992572-02
Vitreous carbon	100cc	EV-CL100VC	992573-02
Molybdenum	2cc	EV-CL2M	992584-03
Molybdneum	6cc	EV-CL6M	990586-03
Molybdneum	7cc	EV-CL7M	990587-03
Molybdneum	15cc	EV-CL15M	990588-03
Molybdneum	25cc	EV-CL25M	990589-03
Molybdenum	30cc	EV-CL30M	992484-03
Molybdneum	40cc	EV-CL40M	990590-03
Molybdneum	60cc	EV-CL60M	990571-03
Molybdneum	75cc	EV-CL75M	990572-03
Molybdneum	I00cc	EV-CL100M	990573-03
-		EV CLATIL	00250404
Tungsten	2cc	EV-CL2TU	992584-04
Tungsten	6cc	EV-CL6TU	990586-04
Tungsten	7cc	EV-CL7TU	990587-04
Tungsten	I5cc	EV-CL15TU	990588-04
Tungsten	25cc	EV-CL25TU	990589-04
Fabmate	2cc	EV-CL2FM	990584-10
Fabmate	6cc	EV-CL6FM	990586-10

Linear material	Crucible size	Reference	Part number
Tungsten	30cc	EV-CL30TU	992484-04
Tungsten	40cc	EV-CL40TU	990590-04
Tungsten	60cc	EV-CL60TU	992571-04
Tungsten	75cc	EV-CL75TU	992572-04
Tungsten	100cc	EV-CLI00TU	992573-04
Boron nitride	2cc	EV-CL2BN	992584-05
Boron nitride	6cc	EV-CL6BN	990586-05
Boron nitride	7cc	EV-CL7BN	990587-05
Boron nitride	15cc	EV-CLI5BN	990588-05
Boron nitride	25cc	EV-CL25BN	990589-05
Boron nitride	30cc	EV-CL30BN	992484-05
Boron nitride	40cc	EV-CL40BN	992590-05
Boron nitride	60cc	EV-CL60BN	992571-05
Boron nitride	75cc	EV-CL75BN	992572-05
Boron nitride	100cc	EV-CLI00BN	992573-05
Alumina	2cc	EV-CL2A	992584-06
Alumina	6cc	EV-CL6A	990586-06
Alumina	7cc	EV-CL7A	990587-06
Alumina	15cc	EV-CLI5A	990588-06
Alumina	25cc	EV-CL25A	990589-06
Alumina	30cc	EV-CL30A	992484-06
Alumina	40cc	EV-CL40A	990590-06
Alumina	60cc	EV-CL60A	992571-06
Alumina	75cc	EV-CL75A	992572-06
Alumina	100cc	EV-CLI00A	992573-06
Copper	2cc	EV-CL2CU	992584-08
Copper	6cc	EV-CL6CU	990586-08
Copper	7cc	EV-CL7CU	990587-08
Copper	15cc	EV-CL15CU	990588-08
Copper	25cc	EV-CL25CU	990589-08
Copper	30cc	EV-CL30CU	992484-08
Copper	40cc	EV-CL40CU	990590-08
Copper	60cc	EV-CL60CU	992571-08
Copper	75cc	EV-CL75CU	992572-08
Copper	I00cc	EV-CLI00CU	992573-08

All dimensions are nominal in millimetres unless specified





The spare parts detailed below are a list of e-Vap® consumable components which may require periodic replacement.

These components have been specifically designed for use with Caburn-MDC e-Vap® electron beam evaporation sources and systems



















Description	Used with frame size	Reference	Part number
Anode	I – 6	EV-EA	990537
Beam deflector shield	1, 2, 5, 6	EV-BDS1256	992201
Beam deflector shield	3, 4	EV-BDS34	990534
Beam former	I – 6	EV-BF	990533
Cathode block LH	1, 2	EV-LCB12	990525-01
Cathode block RH	1, 2	EV-RCB12	990526-01
Cathode block LH	3 – 6	EV-LCB36	990525-02
Cathode block RH	3 – 6	EV-RCB36	990526-02
Emitter assembly	I, 2	EV-EA-1000	990630-01
Emitter assembly, old	51	EV-EA-4010O	990630-02
Emitter assembly	6	EV-EA-4015	990630-03
Emitter assembly	3	EV-EA-4066	990630-04
Emitter assembly	4	EV-EA-4UHV	990630-06
Emitter assembly,new	51	EV-EA-4010N	990630-05
Fasteners, non-galling	I – 6	EV-FK	990585
Filament clamp LH	I – 6	EV-LFC	990531
Filament clamp RH	I – 6	EV-RFC	990532
Filament set, 5 each	1, 2, 6	EV-FIL126	992330
Filament set, 5 each	3, 4, 5	EV-FIL345	990527
Insulator, high voltage	I – 6	EV-IHV	990530
Insulator, filament block	I – 6	EV-IFB	990528
Insulator, beam detector	I – 6	EV-IBDS	990535
Insulator, beam former	I – 6	EV-IBFS	990529

Note Older, frame-five emitter assemblies are fitted with short design anodes as pictured at left

New frame-five emitter assemblies are fitted with new, extended-design anodes as shown at the top of the 'Anode' figure



# **Evaporation source accessories**

#### HF Emitter assembly consumables

The spare parts detailed below are a list of e-Vap® consumable components which may require periodic replacement. These components have been specifically designed for use with MDC e-Vap® electron beam evaporation sources and systems equipped with the HF emitter assembly.

Section 8.5





















#### **Retrofit kit includes:**

- One HF emitter assembly
- One filament installation tool
- One faceplate for emitter
- Permanent magnets: frame sizes five and six only
- Two installation screws
- Detailed instructions

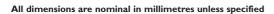
#### Components may be purchased individually or as a complete retrofit kit.

Description	Used with frame size	Reference	Part number
Emitter retrofit kits			
Emitter retrofit kit	1, 2, 5	EV-EAHFI-KIT	992908
Emitter retrofit kit	6	EV-EAHFG-KIT	992909

Emitter assemblies			
Emitter assembly	1, 2, 5	EV-EAHFI	992850-02
Emitter assembly	6	EV-EAHF6	992850-01

Replacement parts			
Anode	I – 6	EV-AHF	992845
Beam deflector shield	I – 6	EV-BDSHF	992846
Filament installation tool	I – 6	EV-FIT	992534-01
Cathode Block LH	I – 6	EV-LCBHF	992853
Cathode block RH	I – 6	EV-RCBHF	992852
Fasteners, non-galling, set of 8	I – 6	EV-FKHF	993042
Filament clamp LH	I – 6	EV-LFCHF	992847-01
Filament clamp RH	I – 6	EV-RFCHF	992847-02

Consumables			
Filament set, 5 each	I – 6	EV-FILHF	990527
Insulator high voltage	l – 6	FV-IHVHF	992414







Listed here are the essential components required for a typical installation of stand-alone modular eVap® electron beam sources. Included are feedthroughs for source water cooling and all electrical interfaces.

Manual and auto-indexer type rotary feedthroughs are available for the installation of multi-pocket sources. All components are fitted with industry-standard vacuum mounts to facilitate source installation onto existing coating systems.

Standard mounts include: Del-Seal™ CF metal seal flanges and 25mm baseplate O-ring seal mounts. Customers with Balzers systems with 32mm baseplate ports can use MDC's 32mm to 25mm baseplate port adaptor.

Description	Reference	Part number
Feedthroughs, water and electrical		
Water, dual 8mm tubes, 70mm Del-Seal™	EV-LF275	991534
Water, dual 8mm tubes, 25mm baseplate	EV-LFI	991726
Sweep coil, 4-pin 1.4mm, 34mm Del-Seal™	EV-IFI33	991531
Sweep coil, 4-pin 1.4mm, 70mm Del-seal™	EV-IF275	991532
Sweep coil, 4-pin 1.4mm, 25mm baseplate	EV-IFI	991727
TC-Crimp contacts for 1.4mm pin, 5 each	TC-CRIMP	991538
High voltage, 2-pin 6.35mm, 12kV, 70mm Del-Seal™	EV-HC275	640005
High voltage, I-pin 8mm, I2kV, 25mm baseplate	EV-HCI	992940
Connector, right-angle power, 6.35mm pin	RAPC	991537
Connector, in-line power, 6.35mm pin	ILPC	991536
Connector, right-angle, 8mm pin	REVHVC	992818-03

Feedthroughs, rotary bellows seal		
Rotary manual, 6.35mm shaft, 34mm Del-Seal™	HTBRM-133	670004
Rotary manual, 6.35mm shaft, 70mm Del-Seal™	HTBRM-275	670005
Rotary 6.35mm shaft both ends, 34mm Del-Seal™	EV-BRMI-133	991731
Rotary 6.35mm shaft both ends, 70mm Del-Seal™	EV-BRMI-275	991730

Feedthroughs, rotary O-ring seal		
Rotary 6.35mm shaft both ends, 25mm baseplate	FRM-I	652000

Assembly equipment		
Baseplate adaptor balzers 32mm to MDC 25mm	EV-BAI	991813
VCR® gland 6.35mm modified 5.5mm bore	EV-MVCR	990610
VCR® gland 6.35mm to 8mm tube adaptor	EV-TAVCR	991809
Waterflow switch, 110V	EV-WFII0	991031
Waterflow switch, 240V	EV-WF240	991031-01
High voltage safety ground hook	EV-SGH	991106
High voltage acrylic shield, 70mm Del-Seal™	HVE-2	64005 I
High voltage acrylic shield, 25mm baseplate	BHVE-2	640057



























